

Taiwan Semiconductor

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-case thermal resistance	R _{eJC}	2	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per diode ⁽¹⁾	UGF2004G	I _F = 10A, T _J = 25°C	V _F	-	0.95	V
	UGF2005G UGF2006G			-	1.25	V
	UGF2007G UGF2008G			-	1.70	V
Reverse current @ rated V _R per diode ⁽²⁾		$T_J = 25^{\circ}C$	- I _R	-	5	μA
		T _J = 125°C		-	100	μA
Reverse recovery time	UGF2004G UGF2005G UGF2006G	I _F = 0.5A , I _R = 1.0A I _{rr} = 0.25A	t _{rr}	-	20	ns
	UGF2007G UGF2008G			-	25	ns

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING
UGF20xG	ITO-220AB	50 / Tube
UGF20xGH	ITO-220AB	50 / Tube

Notes:

1. "x" defines voltage from 200V(UGF2004G) to 600V(UGF2008G)

2. "H" means AEC-Q101 qualified



10

1

0.1

0.01

0.001

20 30 40 50 60 70 80 90

10

INSTANTANEOUS REVERSE CURRENT (µA)

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

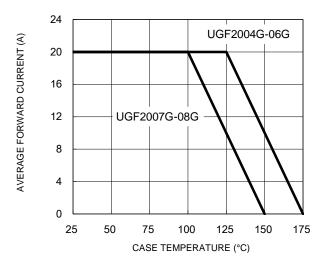


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

T₁=125[°]C

T_=25°C ≣

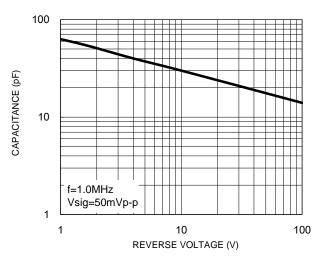
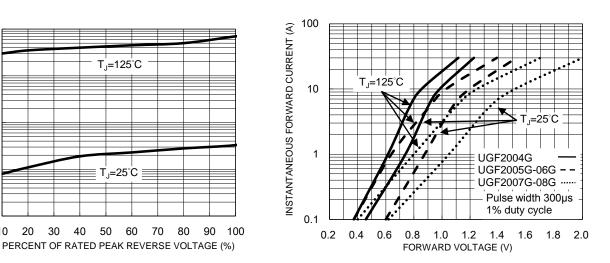


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



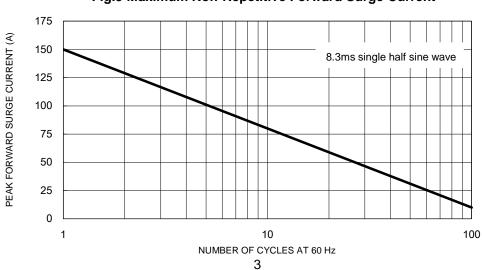


Fig.5 Maximum Non-Repetitive Forward Surge Current

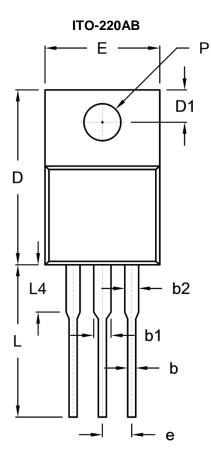
Version: C2105

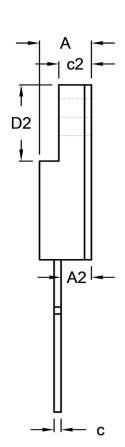


UGF2004G - UGF2008G

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PACKAGE OUTLINE DIMENSIONS





DIM.	Unit	(mm)	Unit (inch)	
DIN.	Min.	Max.	Min.	Max.
A	4.30	4.70	0.169	0.185
A2	2.30	2.96	0.091	0.117
b	0.50	0.90	0.020	0.035
b1	-	1.80	-	0.071
b2	0.95	1.45	0.037	0.057
с	0.46	0.76	0.018	0.030
c2	2.50	3.16	0.098	0.124
D	14.80	15.50	0.583	0.610
D1	2.40	3.20	0.094	0.126
D2	6.30	6.90	0.248	0.272
E	9.60	10.30	0.378	0.406
е	2.41	2.67	0.095	0.105
L	12.60	13.80	0.496	0.543
L4	-	4.10	-	0.161
Р	3.00	3.40	0.118	0.134

MARKING DIAGRAM

জ্র দ্র GYWW <mark>F</mark>
P/N

P/N	= Marking Code
G	= Green Compound
YWW	= Date Code
F	= Factory Code



UGF2004G – UGF2008G

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Taiwan Semiconductor:UGF2004GUGF2005GUGF2006GUGF2008GUGF2005GH